









Release Date: 07 August 2019 Version: A1.0

PRODUCT DATASHEET



- ► PLCC2 SMD
- ▶ 2835 0.7t
- ► Natural White (5000K)

N0W49S73





2835 PLCC2 Series Compliant





FEATURES:

Package: PLCC2 Top View White Package

Forward Current: 150mA Forward Voltage (typ.): 3.1V

Luminous Flux (typ.): 75lm@150mA

Colour: Natural White

Colour Temperature (CCT): 5000K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Finish: Ag plated

Operating Temperature: -40~+85°C Storage Temperature: -40~+100°C **Electrostatics Discharge: 1000V**

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with Max. 18000/reel, ø355mm/14"

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD
- **Architectural Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	240	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	IPF	280	mA
Power Dissipation	P _D	790	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	120	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{THJS}	16	°C/W
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	230 or 260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

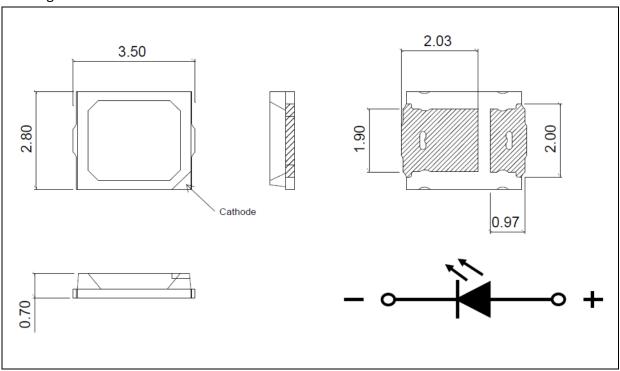
Parameter	Cumbal	Values			l loit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V_{F}	2.7		3.3	V	I _F =150mA	
Luminous Flux	Ф۷	70	75	85	lm	I _F =150mA	
Chromaticity Coordinates	Х		0.3507			I _F =150mA	
	Υ		0.3635				
Colour Temperature	ССТ		5000		К	I _F =150mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =150mA	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V



OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 150mA):

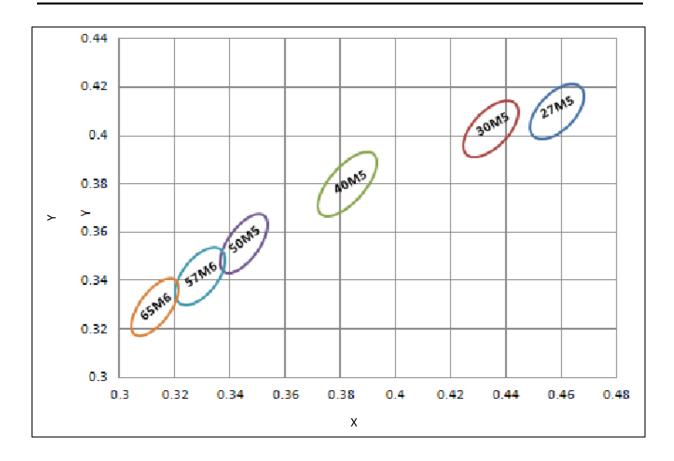
Code	Min.	Max.	Unit
A1	2.7	2.8	
B1	2.8	2.9	
C1	2.9	3.0	V
D1	3.0	3.1	V
E1	3.1	3.2	
F1	3.2	3.3	

Luminous Flux Classifications (I_F = 150mA):

Code	Min.	Max.	Unit	
1W	70	75		
1X	75	80	lm	
5A	80	85		



CIE CHROMATICITY DIAGRAM:

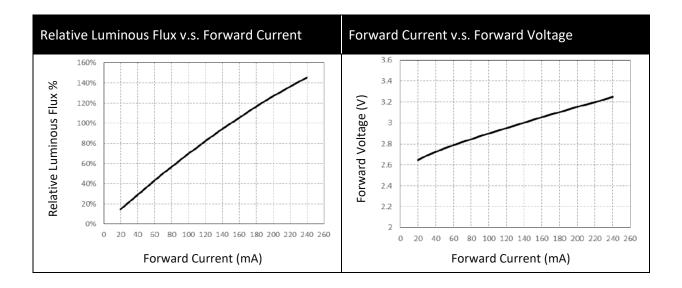


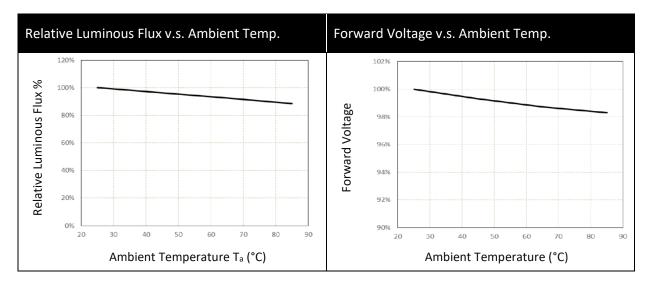
Chromaticity Coordinates Classifications (IF = 150mA):

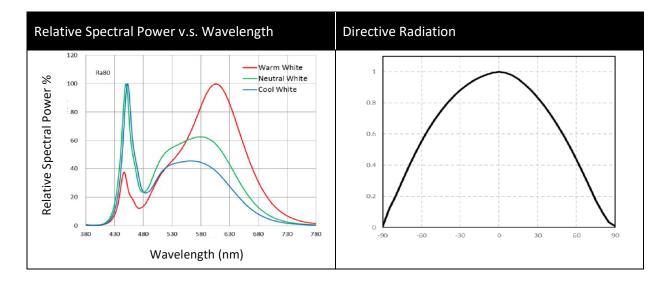
	Code	Centre		Radius		Angle
a /	Code	Х	Υ	а	b	Φ
D D	50R5	0.3507	0.3635	0.01370	0.00590	59.37



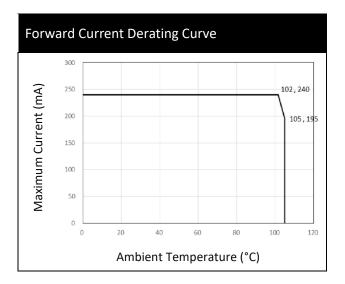
ELECTRO-OPTICAL CHARACTERISTICS:







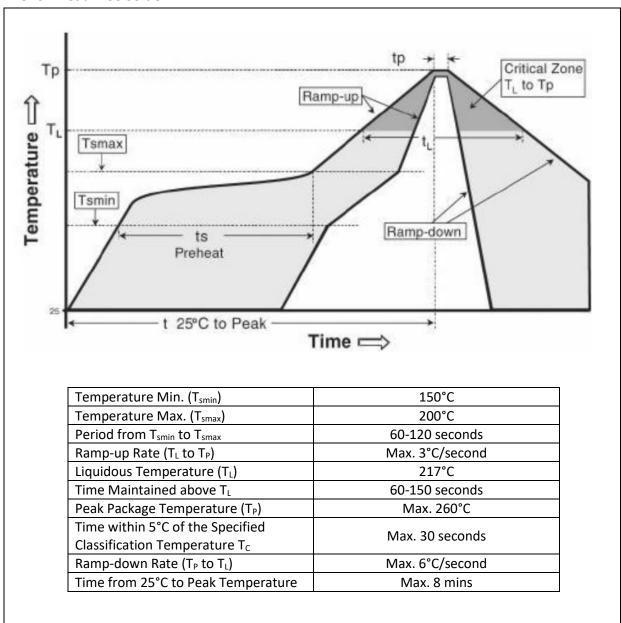






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



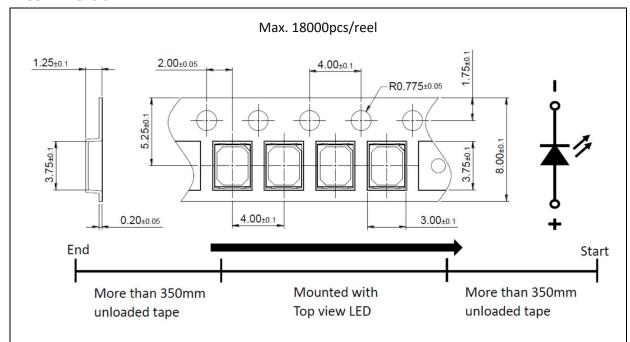
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

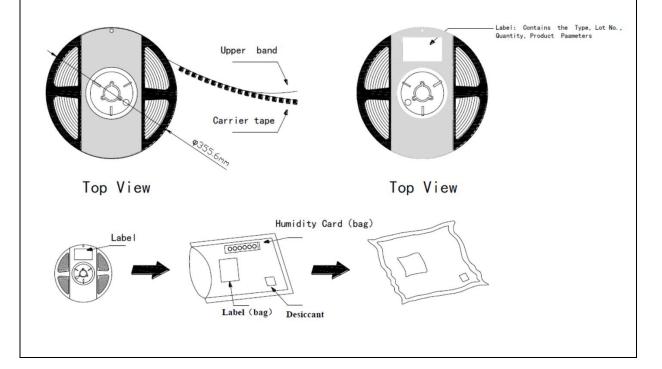


PACKING SPECIFICATION:

Reel Dimension:



1. Cumulative Tolerance: Cumulative Tolerance/10 pitches to be ±0.2mm





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking.

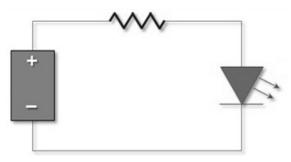
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, worktables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	07/08/2019	Datasheet set-up.